

DESCRIPTION

The SPN8460 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a small outline surface mount package.

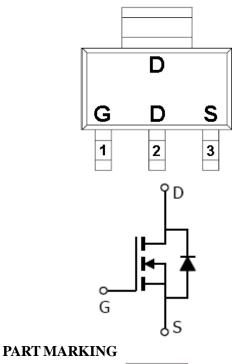
APPLICATIONS

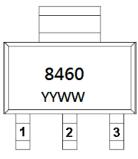
- Power Tool
- DC/DC Converter
- Load Switch

FEATURES

- 60V/2.5A, RDS(ON)= $120m\Omega$ @VGS=10V
- 60V/2.0A, RDS(ON)= $130m\Omega$ @VGS=4.5V
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- SOT-223 package design

PIN CONFIGURATION(SOT-223)





Y: Year Code W: Week Code

PINDESCRIPTION						
Pin	Symbol	Description				
1	G	Gate				
2	D	Drain				
3	S	Source				

ORDERINGINFORMATION

Part Number	Package	Part Marking
SPN8460S22RGB	SOT-223	8460

SPN8460S22RGB: Tape Reel; Pb – Free; Halogen – Free

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		Vdss	60	V
Gate –Source Voltage		VGSS	±20	V
Continuous Drain Current(TJ=150°C)	TA=25°C	- ID	4	A
	Ta=70°C		2.8	71
Pulsed Drain Current		Ірм	25	A
Continuous Source Current(Diode Conduction)		Is	2.5	A
Down Dissination	TA=25°C	PD	3.0	W
Power Dissipation	$TA=70^{\circ}C$		2.0	· vv
Operating Junction Temperature		TJ	150	$^{\circ}\mathbb{C}$
Storage Temperature Range		Tstg	-55/150	$^{\circ}\!\mathbb{C}$
Thermal Resistance-Junction to Ambient		RθJA	42	°C/W

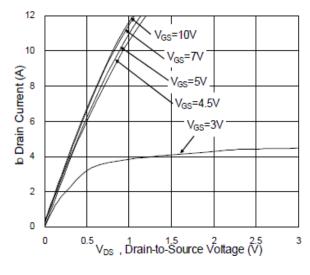


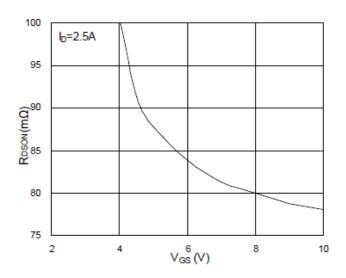
ELECTRICAL CHARACTERISTICS

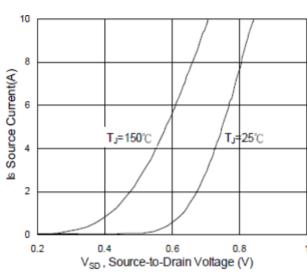
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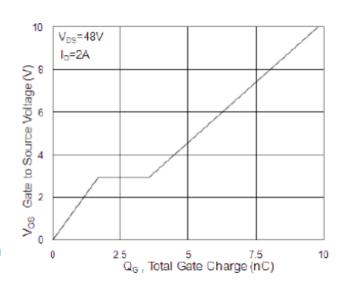
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Static	·					
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID=250uA	60			V
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.5		1.5	
Gate Leakage Current	Igss	VDS=0V,VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	Idss	VDS=48V,VGS=0V VDS=48V,VGS=0V			5	uA
		TJ=55°C			3	
On-State Drain Current	ID(on)	$V_{DS} \ge 10V, V_{GS} = 4.5V$	4			A
Drain-Source On-Resistance	RDS(on)	$V_{GS} = 10V, I_{D}=2.5A$ $V_{GS} = 4.5V, I_{D}=2A$			120 130	mΩ
Forward Transconductance	gfs	VDS=5V,ID=2A		7		S
Diode Forward Voltage	Vsd	Is=2.5A,VGS=0V			1.2	V
Dynamic	<u>.</u>					
Total Gate Charge	Qg	Vds=48V, Vgs=4.5V Id=2A		5	7	nC
Gate-Source Charge	Qgs			1.68	2.4	
Gate-Drain Charge	Qgd			1.9	2.7	
Input Capacitance	Ciss	V _{DS} =15V, V _{GS} =0V f=1MHz		511		pF
Output Capacitance	Coss			38		
Reverse Transfer Capacitance	Crss			25		
Turn-On Time	td(on)	V _{DS} =30V, I _D =2.0A, V _{GS} =10V, R _G =3.3Ω		1.6	3.2	nS
	tr			7.2	13	
Turn-Off Time	td(off)			25	50	
	tf			14.5	29	

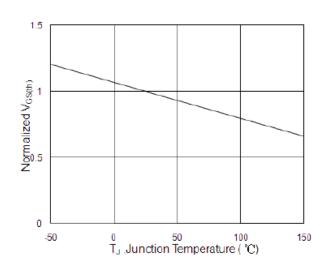
TYPICAL CHARACTERISTICS

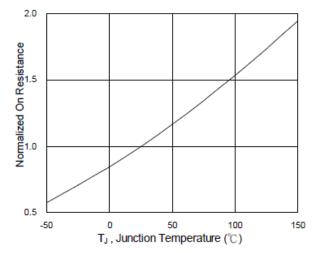




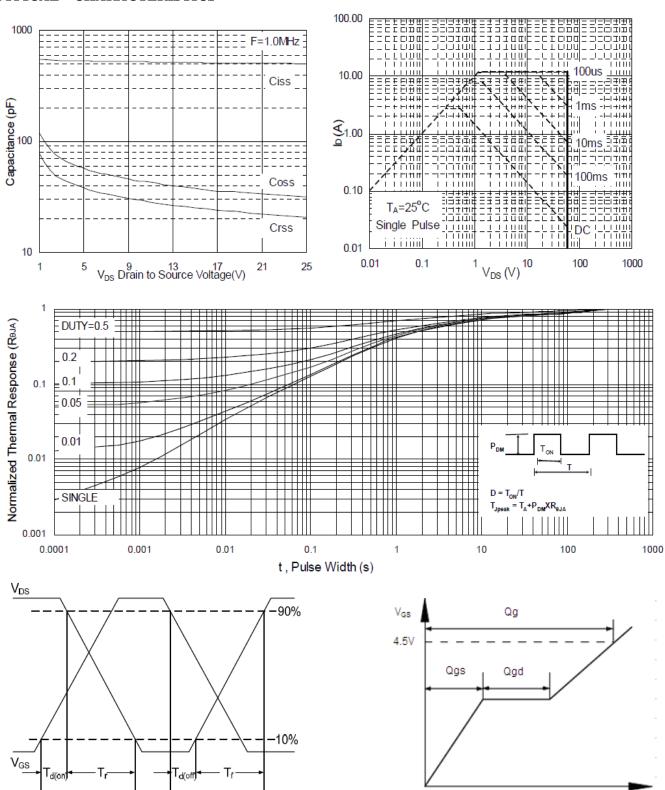








TYPICAL CHARACTERISTICS



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